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Bulletin

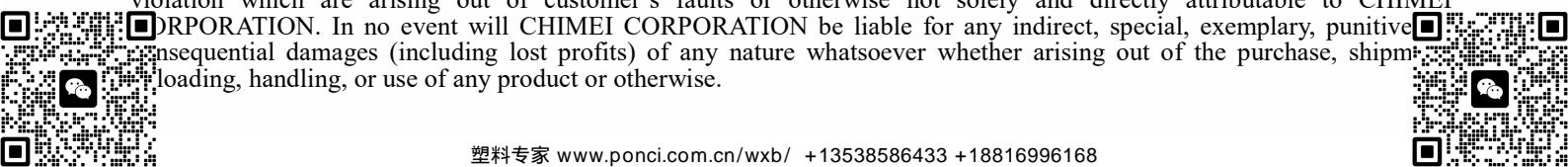
We, CHIMEI CORPORATION, to the best of our knowledge hereby certify that the resins listed below (hereinafter referred as "products") as directly manufactured by us

WONDERLITE® PC	PC-108U, PC-110(U), PC-110L, PC-110V, PC-115(U), PC-115L, PC-115P, PC-115P F01, PC-115P F17111C1, PC-122(U), PC-145K, PC-145K F01, PC-175
WONDERLOY® PC Alloy	PC-330, PC-345, PC-365, PC-385, PC-860

conforms to the requirement that no chemicals as following are intentionally added.

- 1. Halogen (Br, I) and its compounds
- 2. Halogen (Cl)
- 3. PBDEs (Polybrominated Diphenyl Ethers)
- 4. PBBs (Polybrominated Biphenyls)
- 5. Ozone Depleting Chemicals (CFCs & HCFCs)
- 6. Chlorinated Paraffin (C10-C13)
- 7. Polyvinyl Chloride (PVC)
- 8. Mercury (Hg) and its compounds
- 9. Lead (Pb) and its compounds
- 10. Cadmium (Cd) and its compounds
- 11. Chromium (Cr) and its compounds
- 12. Arsenic (As) and its compounds
- 13. Antimony (Sb) and its compounds
- 14. Selenium (Se) and its compounds
- 15. Barium (Ba) and its compounds
- 16. Beryllium (Be) and its compounds
- 17. Bismuth (Bi) and its compounds
- 18. Organic tin compounds (TBT, TPT, DOT, DBT...etc)
- 19. Polychlorinated Biphenyls (PCBs) and Terphenyls (PCTs) and Napthalenes (PCNs)
- 20. Poly naphthalenes
- 21. Azo colorants (according to REACH-ANNEX-XVII-APPENDIX 8)
- 22. Asbestos
- 23. Phthalates
- 24. APEO: Including Alkylphenol(AP), Octylphenol(OP), Nonylphenol(NP), Octylphenol ethoxylates(OPE), Nonylphenol ethoxylates(NPE)
- 28. Triclosan
- 29. Nickel
- 30. PAHs (Polycyclic Aromatic Hydrocarbons)
- 31. REACH- Candidate List of SVHC
- 32. Radioactive Substances
- 33. Natural Latex
- 34. Dioxins and furans
- 35. Primary aromatic amines (PAA)
- 36. Perchlorate
- 37. Hexachlorobenzene
- 38. Mirex
- 39. Specified amine compounds
- 40. Benzene
- 41. Benzenamine, *N*-phenyl-, Reaction Products with Styrene and 2,4,4-Trimethylpentene (BNST)
- 42. Polyamide
- 43. PVDC (polyvinylidene chloride)
- 44. ESBO (Expoxydized soybean oil)
- 45. Formamide
- 46. Hexabromocyclododecane (HBCDD)
- 47. Red phosphorus
- 48. Aniline · formaldehyde polycondensate
- 49. Chlorobenzene
- 50. 4,4'-Sulfonyldiphenol (BPS)
- 51. Cobalt
- 52. PIP (3:1) (phenol, isopropylated phosphate 3:1)
- 53. DecaBDE (decabromodiphenyl ether)
- 54. 2,4,6-TTBP (2,4,6-Tris(tert-butyl)phenol)
- 55. HCBD (hexachlorobutadiene)

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25. 2-(2'-Hydroxy-3',5'-di-tert-butylphenyl)benzotriazole
26. Formaldehyde
27. Dimethylfumarate (DMF)

56. PCTP (pentachlorothiophenol)
57. Perfluorooctanoic acid(PFOA), Perfluorooctane sulfonate(PFOS), Per- and polyfluoroalkyl substances (PFAS)

With regard to composition of above grades of products, the aforesaid products comply with the Directives of RoHS 2011/65/EU and its amendment (EU) 2015/863, TCO'07, Blue Angel and SONY Standard (SS-00259)

Sincerely Yours,



Jones Kuo

Vice President of Research and Development Head Division

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